| ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® | © Co | terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Americ | kburn, Illinois | . All rights reserv | I tion with lower | level | parts, the | declaratio | on encor | npasses all l | | rials for which | the item is an assembly the manufacturer has is declaration. |
|--|-------|--|-----------------|----------------------------------|---|--------------------------------------|------------|--|--|----------------------|-----------------|-----------------|--|
| IPC-1752-1 v1.02 IPC Web Site for Information on IPC http://www.ipc.org/IPC-175x | | | C-1752 Standard | | | m Type * tribute | | Declaration Class * Class 4 - RoHS Yes/No, JIG Format Substances, Mfg Info | | | | | |
| Supplier Information | | | | | | | | | | | | | |
| Company Name * Anaren Microwave, Inc. | | Company Unique ID | | Unique ID A | uthority | Response 2007-06-21 | | * | | Response Document ID | | | |
| Contact Name * Michael Lugert | | | | | | Email - Contact * mlugert@anaren.com | | | Duplicate Contact -> Authorized Representative | | | | |
| Authorized Representative * Michael Lugert | | Title - Representative Product Line Mana | • | | Email - Representative * mlugert@anaren.com | | | * | Supplier Cor | nments or URL | for Additiona | l Information | |
| Requester Item Number | | Mfr Item Number | | Mfr Item Name | ame | | ve Date | Version | Manufa | cturing Site | Weight | UOM | Unit Type |
| | | XC3500M-20S | | Xinger II, M-size, 3.3 - 3.7 GHz | | z | | | East S | yracuse | 0.203 | g | Each |
| Alternate Recommendation | | | | | | | | Alternate | e Item Co | mments | | | |
| Manufacturing Proces | ss In | formation | | | | | | | | | | | |
| Terminal Plating / Grid Array Material Term | | | Terminal B | ase Alloy | J-STD-020 MSL Ra | ating | Peak Prod | ess Body | Temper | ature Max Tir | me at Peak Temp | erature Numb | er of Reflow Cycles |
| Tin (Sn) - immersion Comments | | | CU Alloy | , | 1 | 260 (| | | | 30 sec | conds 3 | | |

| Save the fields in this form to a file Export Data Import fields from a file into this form Import Data | Clear all of the fields on this form Reset Form | Lock the fields on this form to prevent changes | Lock Supplier Fields | | | | | |
|--|--|---|-----------------------------|--|--|--|--|--|
| RoHS Material Composition Declaration | | Declaration Type * | Simplified | | | | | |
| RoHS Directive 2002/95/EC RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium | | | | | | | | |
| Supplier certifies that it gathered the information it provides in this form concerning RoHS restrictive substances using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. | | | | | | | | |
| RoHS Declaration * 1 - Item(s) does not contain RoHS restricted substances per the definition above | | Supplier Acceptance Accept | ed | | | | | |
| Exemptions: If the declared item does not contain RoHS restricted substances per the definition at above and checkboxes will appear below. Check all applicable exemptions. | pove except for defined RoHS exemptions, then s | elect the corresponding respon | se in the RoHS Declaration | | | | | |
| Mercury in compact fluorescent lamps not exceeding 5 mg per lamp. | 7c. Lead in electronic ceramic parts (e.g. piezoe | lectronic devices). | | | | | | |
| 2a. Mercury in straight fluorescent lamps for general purposes not exceeding 10 mg. in halophosphate lamps | 8. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC amending Directive 76/769/EEC relating to restrictions on the marketing and use of certain dangerous substances and preparations piezoelectronic devices). | | | | | | | |
| 2b. Mercury in straight fluorescent lamps for general purposes not exceeding 5 mg. in triphosphate lamps with a normal lifetime | Hexavalent chromium as an anti-corrosion of the carbon steel cooling system in absorption refrigerators | | | | | | | |
| 2c. Mercury in straight fluorescent lamps for general purposes not exceeding 8 mg. in triphosphate 10a. Deca BDE in polymeric applications | | | | | | | | |
| 3. Mercury in straight fluorescent lamps for special purposes. | 10b. Lead in lead/bronze bearing shells and bus | shes | | | | | | |
| 4. Mercury in other lamps not specifically mentioned in this list. | 11. Lead used in compliant pin connector system | ms. | | | | | | |
| 5. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes. | 12. Lead as a coating material for a thermal con | nduction module c-ring. | | | | | | |
| 6a. Lead as an alloying element in steel containing up to 0.35% lead by weight. | 13a. Lead in optical and filter glass. | | | | | | | |
| 6b. Lead as an alloying element in aluminum containing up to 0.4% lead by weight. | 13b. Cadmium in optical and filter glass. | | | | | | | |
| 6c. Lead as an alloying element in copper containing up to 4% lead by weight. | 14. Lead in solders consisting of more than two elements for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight . | | | | | | | |
| 7a. Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead). | 15. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages. | | | | | | | |
| 7b. Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signalling, transmission as well as network management for telecommunications. | | | | | | | | |
| Declaration Signature | | | | | | | | |
| Instructions: Complete all of the required fields on all pages of this form. Select the "Ac | cepted" on the Supplier Acceptance drop-do | wn. This will display the sig | nature area. Digitally sign | | | | | |

the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

Joint Industry Guide (JIG) Material Composition Declaration for Electronic Products

Instructions: Declare whether the item substances exceed the threshold levels shown in the table and report accordingly. Where threshold levels include the words "intentionally added", substances must be declared if they are added intentionally, regardless of threshold level. For each RoHS substance, identified with dual asterisks (**), report the worst case PPM at the homogeneous material level and optionally the total weight of the substance in the item. For all remaining (non-RoHS) JIG A & B substances, and any additional substances, report the total weight and optionally the PPM at the part level for each item.

| | | | | JIG A auto | ofill - No | | JIG B | autofill - No | 0 | All autofill - No |
|-------------------------|--|---------------------------------|------------------------------|--|------------|--|-------|--------------------|---|-------------------|
| JIG Category Name Three | | Threshold Level | Above Threshold Level? | If yes, enter total weight worse case PPM | | | | Description of Use | | Use |
| Level | As defined in the Joint Industry Guide | Intentionally added or PPM | Yes/No | Weight | UoM | | PPM | | | |
| Α | Asbestos | Intentionally Added | No | | mg | | | | | |
| Α | Certain Azo colorants | Intentionally Added | No | | mg | | | | | |
| Α | Cadmium/Cadmium Compounds ** | 75 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Hexavalent Chromium/Hexavalent Chromium Compounds ** | 1000 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Lead/Lead Compounds ** | 1000 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Lead/Lead Compounds - PVC Cables and Wires Only ** | 300 PPM | No | | mg | | | | | |
| Α | Mercury/Mercury Compounds ** | 1000 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Ozone Depleting Substances - Class I (CFCs, HBFCs, etc.) | Intentionally Added | No | | mg | | | | | |
| Α | Ozone Depleting Substances - Class II (HCFCs) | 1000 PPM | No | | mg | | | | | |
| Α | Polybrominated Biphenyls (PBBs) ** | 1000 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Polybrominated Diphenylethers (PBDEs) ** | 1000 PPM or Intentionally Added | No | | mg | | | | | |
| Α | Polychlorinated Biphenyls (PCBs) | Intentionally Added | No | | mg | | | | | |
| Α | Polychlorinated Naphthalenes (> 3 chlorine atoms) | Intentionally Added | No | | mg | | | | | |
| Α | Radioactive Substances | Intentionally Added | No | | mg | | | | | |
| Α | Certain Shortchain Chlorinated Paraffins | Intentionally Added | No | | mg | | | | | |
| Α | Tributyl Tin (TBT) and Triphenyl Tin (TPT) | Intentionally Added | No | | mg | | | | | |
| Α | Tributyl Tin Oxide (TBTO) | Intentionally Added | No | | mg | | | | | |
| В | Antimony/Antimony Compounds | 1000 PPM | No | | mg | | | | | |
| В | Arsenic/Arsenic Compounds | 1000 PPM | No | | mg | | | | | |
| В | Beryllium/Beryllium Compounds | 1000 PPM | No | | mg | | | | | |
| В | Bismuth/Bismuth Compounds | 1000 PPM | No | | mg | | | | | |
| В | Brominated Flame Retardants (other than PBBs or PBDEs) | 1000 PPM | No | | mg | | | | | |
| В | Nickel (external applications only) | 1000 PPM | No | | mg | | | | | |
| В | Certain Phthalates | 1000 PPM | No | | mg | | | | | |
| В | Selenium/Selenium Compounds | 1000 PPM | No | | mg | | | | | |
| В | Polyvinyl Chloride (PVC) | 1000 PPM | No | | mg | | | | | |

OTHER Material Composition Declaration

Requester Instructions: The requester can optionally include additional substances that must be declared for the item on this form. This is in addition to JIG Level A and JIG Level B substances. The requester should enter additional substances as well as the threshold levels that specify the substance at the item level.

Supplier Instructions: Explicitly declare whether the item exceed the threshold level by selecting Yes or No. If the maximum concentration of any substance exceeds the threshold levels defined by the requester, then the substance content must be reported in total weight and/or worst case PPM, along with a description of material use.

| JIG | Category Name | Threshold Level |
|-------|-----------------------------|--------------------------|
| Other | As defined by the Requester | Defined by the Requester |
| + - | | |

Add Other Material Composition to JIG Tab